



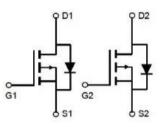
# MJ P-Channel Enhancement Mode Power MOSFET

### Description

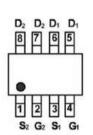
The MJ30PD08S uses advanced trench technology to provide excellent RDS(ON), low gate charge and operation with gate voltages as low as 4.5V.

#### **General Features**

- VDS =-30V,ID =-8A
  RDS(ON) <35mΩ @ VGS=-4.5V</li>
  RDS(ON) <20mΩ @ VGS=-10V</li>
- High power and current handing capability
- Lead free product is acquired
- Surface Mount Package



Schematic diagram



Marking and pin assignment

Application

Battery Switch

Power management

Load switch



SOP-8 top view

# Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
30PD08S	MJ30PD08S	SOP-8	Ø330mm	12mm	4000 units

### Absolute Maximum Ratings (TA=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	-30	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	ID	-8	А
Drain Current-Continuous(Tc =100℃)	ID(100℃)	-5.7	А
Drain Current -Pulsed (Note 1)	Ідм	-32	А
Maximum Power Dissipation	Po	3.1	W
Operating Junction and Storage Temperature Range	Тј ,Тѕтс	-55 To 150	°C

#### Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	Røja	40	°C/W	
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# Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Uni
Off Characteristics		1	1			
Drain-Source Breakdown Voltage	BVDSS	V <sub>GS</sub> =0V,I⊳=-250µA	-30	-33	-	V
Zero Gate Voltage Drain Current	loss	VDS=-30V,VGS=0V	-	-	-1	μA
Gate-Body Leakage Current	lgss	VDS=±20V,VDS=0V	-	-	±100	nA
On Characteristics (Note 3)	I	1	1			
Gate Threshold Voltage	VGS(th)	V⊳s=V₀s,I⊳=-250µA	-1	-1.5	-3	V
		V <sub>G</sub> s=-10V, I <sub>D</sub> =-8A	-	16	20	mΩ
Drain-Source On-State Resistance	Rds(on)	V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-8A	-	21	35	mΩ
Forward Transconductance	<b>G</b> FS	Vds=-5V,Id=-8A	10	-	-	S
Dynamic Characteristics (Note 4)		1				
Input Capacitance	Ciss		-	1600	-	PF
Output Capacitance	Coss	V⊳s=-15V,V₀s=0V F=1.0MHz	-	350	-	PF
Reverse Transfer Capacitance	Crss		-	300	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	td(on)		-	10	-	nS
Turn-on Rise Time	tr	Vdd=-15V, Id=-8A	-	15	-	nS
Turn-Off Delay Time	td(off)	Vgs=-10V,Rgen=6Ω	-	110	-	nS
Turn-Off Fall Time	tr		-	70		nS
Total Gate Charge	Qg		-	30		nC
Gate-Source Charge	Qgs	V <sub>DS</sub> =-15V,I <sub>D</sub> =-8A V <sub>GS</sub> =-10V	_	5.5		nC
Gate-Drain Charge	Qgd		-	8	-	nC
Drain-Source Diode Characteristics	I	1	<u> </u>	1	I	1
Diode Forward Voltage <sup>(Note 3)</sup>	Vsd	Vgs=0V,Is=-8A	_	_	-1.2	v

#### Notes:

(1) Repetitive Rating: Pulse width limited by maximum junction temperature.

(2) Surface Mounted on FR4 Board, t  $\leq$  10 sec.

(i) Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2%.

4 Guaranteed by design, not subject to production





# Typical Electrical and Thermal Characteristics

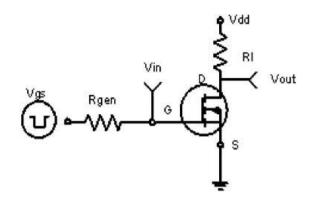
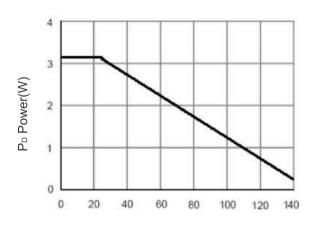
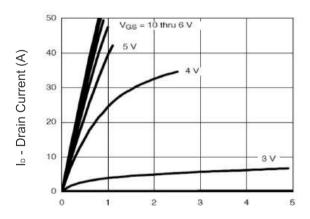


Figure 1 Switching Test Circuit



Tյ-Junction Temperature(℃) Figure 3 Power Dissipation



Vds Drain-Source Voltage (V) Figure 5 Output Characteristics

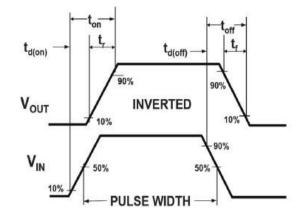
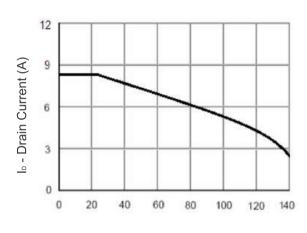
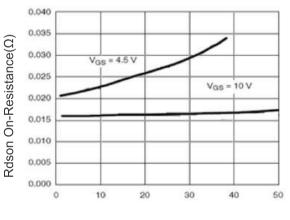


Figure 2 Switching Waveforms



TJ-Junction Temperature(°C) Figure 4 Drain Current



I<sub>D</sub>- Drain Current (A) Figure 6 Drain-Source On-Resistance





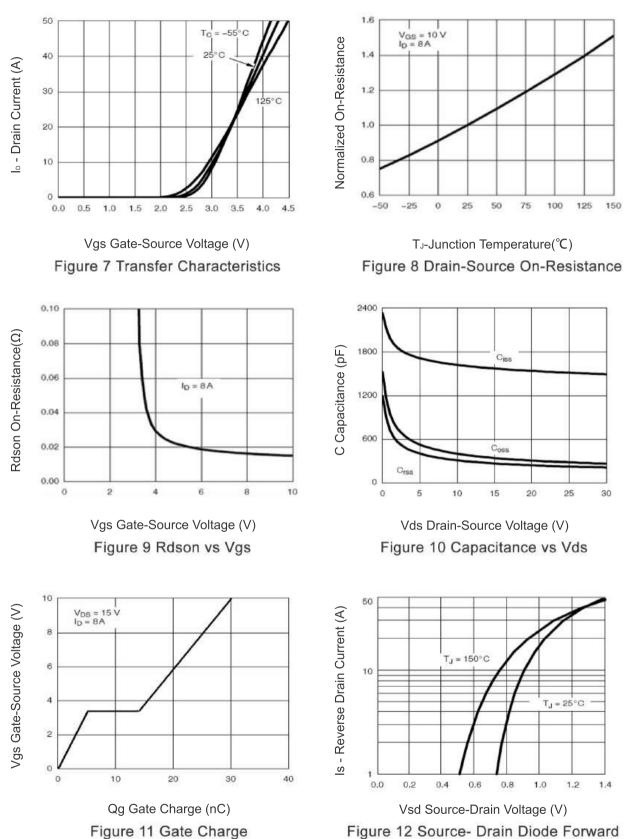
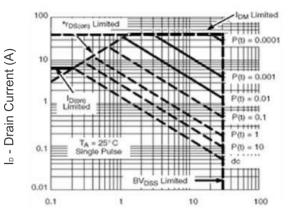


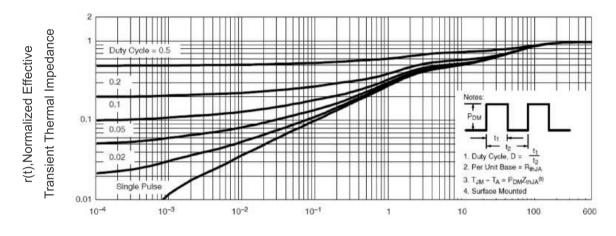
Figure 12 Source- Drain Diode Forward







Vds Drain-Source Voltage (V) Figure 13 Safe Operation Area

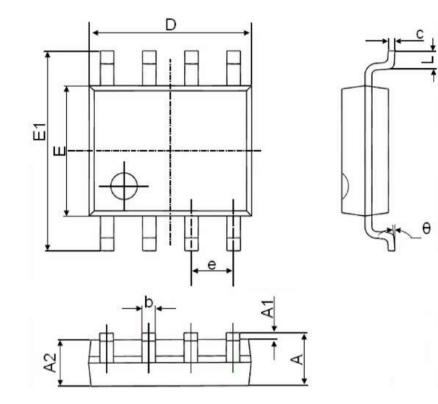


Square Wave Pluse Duration(sec) Figure 14 Normalized Maximum Transient Thermal Impedance





# SOP-8 Package Information



Sumbol	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
с	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.200	
E	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
е	1.270	1.270(BSC)		(BSC)	
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	





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